

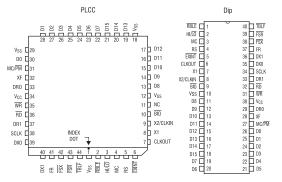
Features

- · Direct A-Law PCM digital input
- · 2.048 Mb/s clocking
- Programmable forward/backward mode
- Programmable compelled/direct control
- Operates with standard codecs for analog interfacing
- Microprocessor read/write interface
- Binary or 2-of-6 data formats
- Single- or dual-channel versions
- 5 volt power

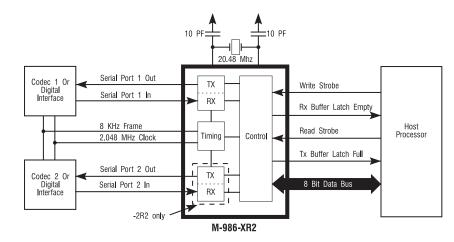
Applications

- Test equipment
- Trunk adapters
- · Paging terminals
- Traffic recorders
- PBXs

Pin Assignments



Block Diagram



Description

The M-986-1R2 and -2R2 MFC Transceivers contain all the logic necessary to transmit and receive CCITT R2F (forward) and R2B (backward) multifrequency signals on one 40-pin integrated circuit (IC). M-986-1R2 is a single-channel version; M-986-2R2 provides two channels. R1 single and dual multifrequency transceivers are also available as M-986-1R1 and -2R1.

Operating with a 20.48 MHz crystal, the M-986 is capable of providing a direct digital interface to an Alaw-encoded PCM digital input. Each channel can be connected to an analog source using a coder-decoder (codec) as shown in the Block Diagram below.

The M-986 can be configured by the customer to operate with the transmitter and receiver either coupled together or independently, allowing it to handle a compelled cycle automatically or via command from the host processor. For the R2 versions of the M-986, A-law is used for coding/decoding. The M-986 is configured and controlled through an integral coprocessor port.

Ordering Information

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Part #	Description
M-986-1R2P	40-pin plastic DIP, Single Channel
M-986-1R2PL	44-pin PLCC, Single Channel
M-986-2R2P	40-pin plastic DIP, Dual Channel
M-986-2R2PL	44-pin PLCC, Dual Channel



Function Description

The M-986 can be set up for various operating modes by writing two configuration bytes to the coprocessor port.

Configuration Options

External/Internal Codec Clock (ECLK): If external codec clocking is selected, an external clocking source provides an 8kHz transmit framing clock and an 8kHz receive framing clock. It also provides a serial bit clock with a frequency that is a multiple of 8 kHz between 2.496 MHz and 216 kHz for exchange of data via the serial ports. When internal codec clocking is selected, the M-986 provides an 8kHz framing clock and a 2.048 MHz serial bit clock.

Binary/2 of 6 Input/Output (IOM): When the 2-of-6 input/output is selected, the M-986 encodes the received R2 MF tone pair into in a 6-bit format, where each bit represents one of the six possible frequencies. A logic high level indicates the presence of a frequency. The digital input to the M-986 that selects the transmitted R2 MF tone pair must also be coded in the 2-of-6 format.

When binary input/output is selected, the M-986 encodes the received R2 MF tone pair into a 4 bit binary format. The digital input to the M-986 that selects the transmitted R2 MF tone pair must also be coded in a 4 bit binary format.

Enable/Disable Channel (ENC): When a channel is disabled, the receiver does not process its codec input for R2 MF tones, and the transmitter does not respond to transmit commands. If a transmit command is given while the channel is enabled, the "tone off" command must be given before the channel is disabled. Disabling the channel does not automatically shut off the transmitter. When a channel is enabled, the receiver and transmitter for that channel function normally.

End-of-Digit Indication (EOD): The end-of-digit indication option configures the M-986 to inform the host processor when the far end terminates transmission of the R2 MF tone it is sending. If this option is disabled, the host processor will not be notified when tone transmission terminates.

Automatic Compelled/Manual Sequence Signaling (CMP): When manual mode is selected, R2 MF tone transmission is turned on and off only via command from the host processor.

If the automatic mode is selected, the transmitter and receiver perform the compelled signaling handshake automatically. The specifics of operation are different for the forward and backward configurations.

In forward mode, the transceiver can exist in two states, STATE 1 and STATE 2:

- STATE 1: No backward signal detected. Transmitter under control of the host.
- STATE 2: Backward signal detected. Transmitter off unconditionally.

Configuration Byte 1										
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
0	0	ECLK	IOM	ENC1	EOD1	CMP1	FB1			
ECLK	Chan	nels 1 & 2	1 = External co	dec clock; 0 = Inte	rnal codec clock	ζ.				
IOM	Chan	nels 1 & 2	1 = Binary inpu	ut/output; 0 = 2-of	-6 input/output					
ENC1	Chan	nel 1	1 = Enable cha	annel; 0 = Disable	channel					
EOD1	Char	inel 1	1 = Indicate e	nd of digit; 0 = No	end of digit ind	ication				
CMP1	CMP1 Channel 1			1 = Automatic Compelled mode; 0 = Manual mode						
FB1	Chan	nel 1	1 = Forward mode (Tx forward frequencies and Rx backward frequencies)							
			0 = Backward r	node (Tx backward	d frequencies an	d Rx forward free	juencies)			
			Configura	tion Byte 2						
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
0	1	0	0	ENC2	EOD2	CMP2	FB2			
ENC2	Chan	nel 2	1 = Enable channel; 0 = Disable channel							
EOD2	Char	inel 2	1 = Indicate end of digit; $0 =$ No end of digit indication							
CMP2	CMP2 Channel 2		1 = Automatic Compelled mode; 0 = Manual mode							
FB2	Chan	nel 2	1 = Forward mode (Tx forward frequencies and Rx backward frequencies)							
			0 = Backward r	node(Tx backward	l frequencies and	d Rx forward freq	uencies)			

Configuration Bytes



A Transmit Tone Command written while the transceiver is in STATE 1 will be acted upon immediately. The transmitter is unconditionally disabled upon entry into STATE 2. If a transmit command is written to the transceiver while in STATE 2, that command will become pending. Upon entry into STATE 1, a pending transmit command is acted upon.

In backward mode, the transceiver can exist in two states, STATE 1 and STATE 2:

STATE 1: No forward signal detected. Transmitter off unconditionally.

STATE 2: Forward signal detected.

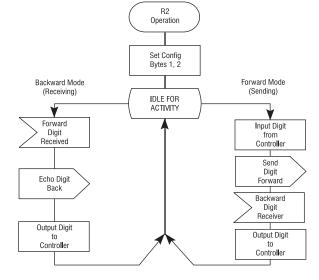
Transmitter transmits backward signal.

A transmit tone command written while the transceiver is in STATE 2 will be acted upon immediately. The transmitter is unconditionally disabled upon entry into STATE 1. If a transmit command is written to the transceiver while in STATE 1, that command will become pending. Upon entry into STATE 2, a pending transmit command is acted upon.

EXAMPLE: Assume that the transceivers at both ends of a link are configured in automatic compelled mode.

Both transceivers are in STATE 1. A compelled signaling sequence begins with the R2F host writing a transmit command byte to its transceiver via the coprocessor bus. The transceiver immediately begins transmitting the signal.

Automatic Compelled Mode Operation

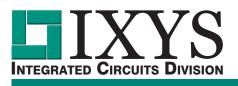


2 of 6 Coding Format

Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0				
Transmit tone command	1	CHN	F6	F5	F4	F3	F2	F1				
Receive tone return	0	CHN	F6	F5	F4	F3	F2	F1				
CHN: $1 = \text{channel } 2; 0 = \text{ch}$	CHN: 1 = channel 2; 0 = channel 1											
R2 MF Frequencies:												
Bit name For	ward (Hz)	ard (Hz) Backward (Hz)		Bit name	Forward (Hz)		Backward (Hz)					
F6 198	0	540		F3	1620		900					
F5 186	0	660		F2	1500		1020					
F4 174	0	780		F1	1380		1140					

Binary Coding Format

Byte	e	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Transmit tone cor	nmand	1	CHN	0	0	A	В	С	D
Receive tone retu	rn	0	CHN	0	0	A	В	С	D
CHN: 1 = channe	el 2; 0 = ch	annel 1			-	•		•	
R2 MF Frequen	cies:								
ABCD	Forw	ard (Hz)	Backwai	d (Hz)	ABCD	Forw	ard (Hz)	Backwar	d (Hz)
0000	Tone	off	Tone off	. ,	1000	1500 8	k 1860	1020 & 660	、
0001	1380 8	§ 1500	1140 & 10	20	1001	1620 8	k 1860	900 & 660	
0010	1380 8	& 1620	1140 & 90	0	1010	1740 8	k 1860	780 & 660	
0011	1500 8	& 1620	1020 & 90	0	1011	1380 8	k 1980	1140 & 540	
0100	1380 8	& 1740	1140 & 78	0	1100	1500 8	k 1980	1020 & 540	
0101	1500 8	& 1740	1020 & 780		1101	1620 8	k 1980	900 & 540	
0110	1620 8	& 1740	900 & 780)	1110	1740 8	k 1980	780 & 540	
0111	1380 8	& 1860	1140 & 66	0	1111	1860 8	k 1980	660 & 540	



The R2B transceiver detects the signal, enters STATE 2, and outputs the received tone code to its host via the coprocessor port. If the R2B host had determined the next tone to transmit and written a transmit command to the transceiver prior to entry into STATE 2, the state transition will cause this tone to be transmitted. Otherwise, the R2B transmitter waits for a transmit tone command from the host, and starts transmitting a tone once the transmit tone command is received.

The R2F transceiver detects the backward signal, enters STATE 2, and outputs the received tone code to its host. Entry into STATE 2 unconditionally disables the transmitter.

The R2B transceiver detects the absence of signal, enters STATE 1, and informs the host with the end-oftone code if configured to do so. Entry into STATE 1 unconditionally disables the transmitter.

The R2F transceiver detects the absence of signal, enters STATE 1, and informs the host with the end-oftone code if configured to do so. If the R2F host had determined the next signal to transmit and written a transmit command to the transceiver prior to entry into STATE 1, the state transition will cause this signal to be transmitted. Otherwise, the transmitter remains silent until the next transmit command by its host.

Forward/Backward Frequencies (FB): When forward mode is selected, the R2F (forward) frequencies are transmitted and R2B (backward) frequencies are received. When backward mode is selected, R2B frequencies are transmitted and R2F frequencies are received. The R2F frequencies are 1380, 1500, 1620, 1740, 1860, and 1980 Hertz. The R2B frequencies are 540, 660, 780, 900, 1020, and 1140 Hz.

Initial Configuration: The configuration of the M-986 immediately after a reset will be as follows:

- · End-of-digit indication ON
- Forward mode ON
- · Channel disabled
- · 2-of-6 input/output
- External serial and serial frame clocks.

Also, the M-986 will place 00 hex on the coprocessor port to indicate to the host processor that it is working.

Transmit Tone Command

The transmit tone command allows the host processor to transmit any two of the 6 possible frequencies in the transmission mode the channel has been configured for (forward or backward). The format of the command depends on whether the M-986 is configured for binary format or 2-of-6 format.

Recieved Tone Detection

When a tone is detected by the M-986, the TBLF output goes low, indicating reception of the tone to the host processor. The host processor can determine which tone was detected and which channel the tone was detected on by reading data from the M-986 coprocessor port. The M-986 will return a single byte indicating the tone received and the channel that the tone was received on.The format of the returned byte depends on whether the M-986 is configured for binary or 2-of-6 coding.

Coprocessor Port

Commands are written to the M-986 via the coprocessor port, and data indicating the received R2 MF tone is read from the coprocessor port.

Writing to the Coprocessor Port: The following sequence describes writing a command to the M-986.

(1) The $\overline{\text{WR}}$ signal is driven low by the host processor.

(2) The RBLE (receive buffer latch empty) signal transitions to a logic high level.

(3) Data is written from <u>LD7</u>-LD0 to the receive buffer latch (D7-D0) when the WR signal goes high.

(4) The RBLE signal transitions to a logic low level after the M-986 reads the data. This signals the host processor that the receive buffer is empty.

Note: The RBLE should be low before writing to the coprocessor.

Reading the Coprocessor Port: The following sequence describes reading received tone information from the coprocessor port.

(1) The TBLF (transmit buffer latch full) port pin on the M-986 goes low indicating the reception of a tone.

(2) <u>The host processor detects the low logic level on</u> the TBLF pin either by polling a connected port pin or by an interrupt.

(3) The host processor drives the \overline{RD} signal low.

(4) The TBLF (transmit buffer latch full) signal transitions to a logic high level.

(5) Data is driven onto LD7-LD0 by the M-986 until the RD signal is driven high by the host processor.

Clock Characteristics and Timing

Internal Clock Option: The internal oscillator is enabled by connecting a crystal across X1 and X2/CLKIN. The crystal must be 20.48 MHz, fundamental mode, and parallel resonant, with an effective series resistance of 30 ohms, a power dissipation of 1 mW, and be specified at a load capacitance of 20 pF.



External Clock Option: An external frequency source can be used by injecting the frequency directly in X2/CLKIN, with X1 left unconnected. The external frequency injected must conform to the specifications listed in the External Frequency specification Table on page 7.

Flammability/Reliability Specifications

Reliability:	
Flammability:	

185 FITS failures/billion hours Passes UL 94 V-0 tests

Signal Description

Signal	DIP Pinout	PLCC Pinout	I/O/Z	Description
Note: Pl	ease see the foll	owing definitions	: DIP = Dual In-l	ine Package PLCC = Plastic Leaded Chip Carrier
D15-D8	18-11	13-17, 19-21	I/O/Z	Unused. Leave open.
D7-D0	19-26	22-28, 30	I/O/Z	8-bit coprocessor latch.
TBLF	40	44	0	Transmit buffer latch full flag.
RBLE	1	2	0	Receive buffer latch empty flag
HI/LO	2	3	I	Latch byte select pin. Tie low.
BIO	9	10	I	Unused. Leave open.
RD	32	36	I/O	Used by the external processor to read from the coprocessor latch by driving the RD line active (low), thus enabling the output latch to drive the latched data. When the data has been read, the external device must bring the RD line high.
EXINT	5	6	I	Unused. Leave open.
MC	3	4	I	Microcomputer mode select pin. Tie low.
MC/PM	27	31	I	Coprocessor mode select pin. Tie low.
RS	4	5	I	Res <u>et input</u> for initializing the device. When an a <u>ctive</u> low is placed on RS pin for a minimum of five clock cycles, RD and WR are forced high, and the data bus (D7 through D0) goes to a high impedance state. The serial port clock and transmit outputs also go to the high impedance state.
WR	31	35	I/O	Used by the external processor to write data to the coprocessor port. To write data the external processor drives the WR line low, places data on the data bus, and then drives the WR line high to clock the data into the on-chip latch.
XF	28	32	Ο	Watchdog signal. Toggles at least once every 15 milliseconds when the processor is functioning properly. If the pin is not toggled at least once every 15 ms, the processor is lost and should be reset.
CLKOUT	6	7	0	System clock output (one-fourth crystal/CLKIN frequency, nominally 5.12 MHz).
V _{cc}	30	34	I	5V supply pin.
V _{ss}	10	1, 12, 18, 29	I	Ground pin.
X1	7	8	0	Crystal output pin for internal oscillator. If an internal oscillator is not used, this pin should be left unconnected.
X2/CLKIN	8	9	I	Input pin to the internal oscillator (X2) from the crystal. Alternatively, an input pin for the external oscillator (CLKIN).
DR1 & DR0	33 & 29	37, 33	I	Serial-port receive-channel inputs. 2.048 MHz serial data is received in the receive registers via these pins. DR0 = channel 1; DR1 = channel 2
DX1 & DX0	36 & 35	40, 39	0	Serial-port transmit-channel outputs. 2.048 MHz serial data is transmitted from the transmit registers on these pins.These outputs are in the high-impedance state when not transmitting.

Signal Description (continued)

Signal	DIP Pinout	PLCC Pinout	I/O/Z	Description
FR	37	41	0	8 kHz internal serial-port framing output. If internal clocking is selected, serial-port transmit and receive operations occur simultaneously on an active (high) FR framing pulse.
FSR	39	43	I	8 kHz external serial-port receive-framing input. If external clocking is selected, data is received via the receive pins (DR1 and DR0) on the active (low) FSR input. The falling edge of FSR initiates the receive process, and the rising edge causes the M-986 to process the data.
FSX	38	42	I	8 kHz external serial-port transmit-framing input. If external clocking is enabled, data is transmitted on the transmit pins (DX1, DX0) on the active (low) input. The falling edge of FSX initiates the transmit process,and the rising edge causes the M-986 to internally load data for the next cycle.
SCLK	34	38	I/O/Z	2.048 MHz serial-port clock. Master clock for transmitting and receiving serial-port data. Configured as an input in external clocking mode or output in internal clocking mode. Reset (RS) forces SCLK to the high-impedance state.

Absolute Maximum Ratings Over Specified Temperature

Supply voltage range, V_C	-0.3 V to 7 V
Input voltage range	-0.3 V to 15 V
Output voltage range	-0.3 V to 15 V
Ambient air temperature range	0°C to 70°C
Storage temperature range	-45°C to 150°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this data sheet is not implied. Exposure of the device to the absolute maximum ratings for an extended period may degrade the device and effect its reliability.

Serial Port Timing

	Parameter	Min	Nom	Max	Units
t _d (CH-FR)	Internal framing delay from SCLK rising edge	-	-	70	ns
t _d (DX1-CL)	DX bit 1 valid before SCLK falling edge	20	-	-	ns
t _d (DX2-CL)	DX bit 2 valid before SCLK falling edge	20	-	-	ns
t _h (DX)	DX hold time after SCLK falling edge	244	-	-	ns
t _{su} (DR)	DR setup time before SCLK falling edge	20	-	-	ns
t _h (DR)	DR hold time after SCLK falling edge	20	-	-	ns
t _c (SCLK)	Serial port clock cycle time	399	488.28	4770	ns
t _f (SCLK)	Serial port clock fall time	-	-	30	ns
t _r (SCLK)	Serial port clock rise time	-	-	30	ns
t _w (SCLKL)	Serial port clock low-pulse duration*	220	244.14	2500	ns
t _w (SCLKH)	Serial port clock high-pulse duration*	220	244.14	2500	ns
t _{su} (FS)	FSX/FSR setup time before SCLK falling edge	100	-	-	ns

 * The duty cycle of the serial port clock must be within 45% to 55%.



Electrical Characteristics/Temperature Range

	Paramete	r	Test Con	nditions	Min	Тур	Max	Unit
I _{cc}	Supply current		f=20.5MHz, V _{cc} =	5.5V,	-	50	75	mA
			$T_A = 0^\circ$ to 70 °C					
V _{OH}	High-level output	voltage	I _{OH} = MAX		2.4	3	-	V
			I _{OH} = 20μA		V _{cc} -0.4	-	-	V
V _{OL}	Low-level output v	oltage	I _{OL} = MAX	$I_{OI} = MAX$		0.3	0.6	V
I _{oz}	Off-state output cu	ırrent	$V_{CC} = MAX$	VO = 2.4 V	-	-	20	μA
				VO = 0.4 V	-	-	-20	μA
4	Input current		$V_1 = V_{SS}$ to V_{CC}	Except CLKIN	-	-	±20	μA
				CLKIN	-	-	± 50	μA
C	Input capacitance	Data bus	f = 1 MHz, all ot	ther pins 0 V	-	25	-	pF
		All others			-	15	-	pF
Co	Output capacitance	Data bus			-	25	-	рF
		All others			-	10	-	pF

External Frequency Specifications

	Parameter	Min	Nom	Max	Unit
t _c (MC)	Master clock cycle time	48.818	48.828	48.838	ns
t _r (MC)	Rise time master clock input	-	5	10	ns
t _f (MC)	Pulse duration master clock	20	-	-	ns

Recommended Operating Conditions

	Paramete	Min	Nom	Max	Unit	
V _{cc}	Supply voltage		4.75	5	5.25	V
V _{ss}	Supply voltage	Supply voltage			-	V
V _{IH}	High-level input voltage	All inputs except CLKIN	2	-	-	V
		CLKIN	3	-	-	V
		MC/PM	2.2	-	-	V
V _{IL}	Low-level input voltage	All inputs except MC/MP	-	-	0.8	V
		MC/MP	-	-	0.6	V
I _{он}	High-level output current (all output	s)	-	-	-300	μA
I _{OL}	Low-level output current (all output	s)	-	-	2	mA

Coprocessor Interface Timing

	Parameter	Min	Nom	Max	Unit
t _{d(R-A)}	RD low to TBLF high	-	-	75	ns
t _{d(W-A)}	WR low to RBLE high	-	-	75	ns
t _{a(RD)}	RD low to data valid	-	-	80	ns
t _{h(RD)}	Data hold time after \overline{RD} high	25	-	-	ns
t _{su(WR)}	Data setup time prior to \overline{WR} high	30	-	-	ns
t _{h(WR)}	Data hold time after WR high	25	-	-	ns
t _{w(RDL)}	RD low-pulse duration	80	-	-	ns
t _{w(WRL)}	WR low-pulse duration	60	-	-	ns
t _{wr(RBLE)}	RBLE↑ to RBLE↓	-	-	1	ms



Reset (RS) Timing

	Parameter	Test Conditions	Min	Мах	Unit
t _{dis} (R)	Data bus disable time after \overline{RS}	R _L = 825	-	75	ns
t _{d12}	Delay time from $\overline{\text{RS}}$ to high-impedance SCLK $C_{L} = 100 \text{ pF}\Omega$		-	200	ns
t _{d13}	Delay time from $\overline{RS}\downarrow$ to high-impedance DX1, DX0		-	200	ns
t _{su} (R)				-	ns
t _{w(} R)				-	ns

CLKOUT Timing Parameters

	Parameter	Test Conditions	Min	Nom	Max	Unit
t _{c(C)}	CLKOUT cycle time		195.27	195.31	195.35	ns
t _{r(C)}	CLKOUT rise time	R _L = 825	-	10	-	ns
t _{f(C)}	CLKOUT fall time	C _L = 100 pFΩ	-	8	-	ns
t _{d(MCC)}	Delay time CLKIN↑ to CLKOUT↓		25	-	60	ns

Transmitter Characteristics

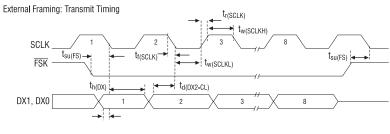
	Parameter	Test Conditions	Min	Тур	Max	Unit
Fos	Frequency offset	From nominal	-	-	±1	Hz
Tw	Twist	High/low	-	-	±0.5	dB
As	Signal amplitude	Per component	-9.26	-8.86	-8.46	dBm0
Τ _s	Time skew	Between components	-	-	0	ms
P _{hi}	Power due to harmonic distortion and					
	intermodulation	300 to 3400 Hz	-	-	-46.5	dBm0

Receiver Characteristics

	Parameter	Test Conditions	Min	Max	Unit
A _d	Detect amplitude	Per frequency	-35	-5	dBm0
A _{nd}	No-detect amplitude	Per frequency	-42	-35	dBm0
F _d	Detect with frequency offset	From nominal	±10	-	Hz
TW _d	Detect with twist	Adjacent frequencies	÷	-	dB
		Nonadjacent frequencies	±7	-	dB
TW _{nd}	No detect with twist		±20	-	dB
T3 _r	Third R2F tone reject Relative to highest level frequency		-20	-	dB
FF _d	Detect R2B with R2F disturbing	Above lowest level R2B tone (-12.5 dBm0 max.)	13.5	-	dB
FT _{nd}	No detect R2F with 2 out-of-band sine waves	Any frequencies from 330 - 1150 Hz and 2130 - 3400 Hz	-5	-	dBm0
RT _{nd}	No detect R2B with 2 out-of-band sine waves	Any frequencies from 1300-3400 Hz	-5	-	dBm0
T _{on}	Tone time	Reject	7	-	ms
T _{int}	Interrupted tone time	Reject	7	-	ms
T _{or}	Operate and release time	·		-	80

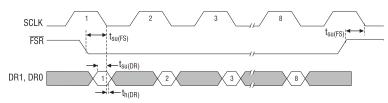


External Framing Timing Diagrams

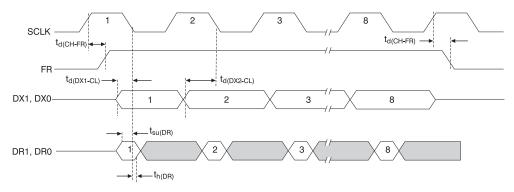


NOTES: Data valid on transmit outputs until SCLK rises. The most significant bit is shifted first.



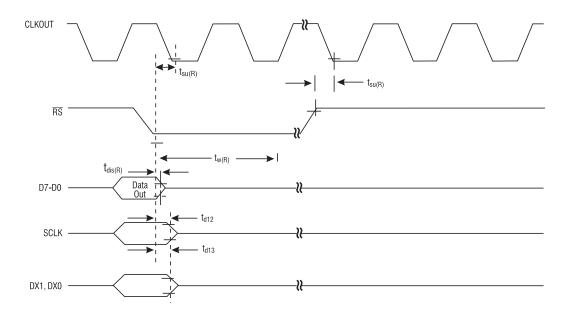


Internal Framing Timing

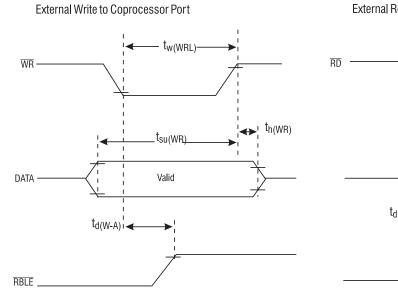


Note: The most significant bit is shifted first.

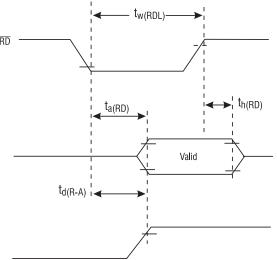




Coprocessor Timing

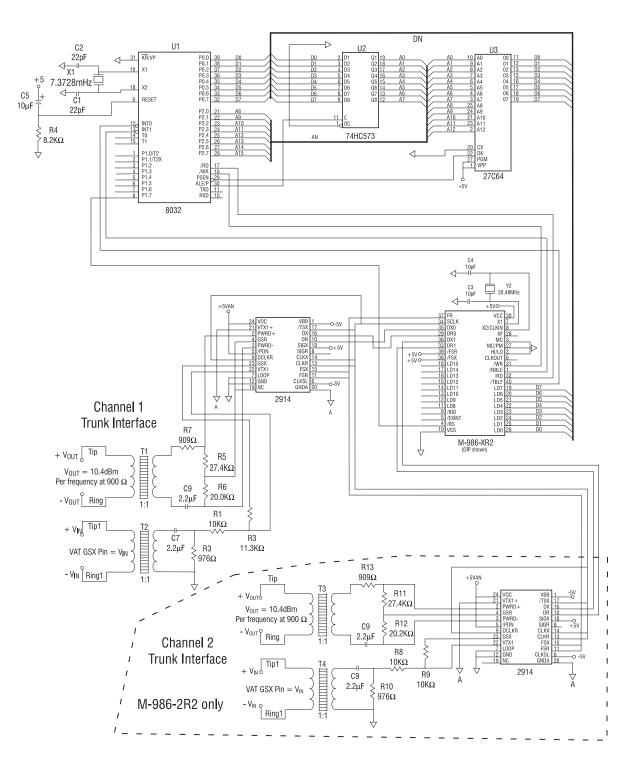


External Read from Coprocessor Port





M-986 Dual Channel 4-Wire Interface Circuit





Manufacturing Information

ESD Sensitivity

This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time		
All Versions	245°C for 30 seconds		

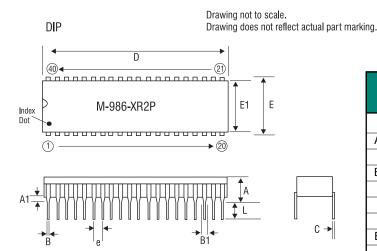
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



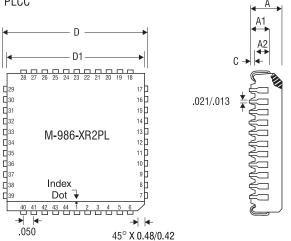


Mechanical Dimensions



	Tolerances				
	(inc	hes)	Metric	: (mm)	
	Min	Max	Min	Max	
А	-	.250	-	6.35	
A1	.015	-	.39		
В	.014	.022	.356	.558	
B1	.030	.070	.77	1.78	
С	.008	.015	.204	.38	
D	1.98	2.095	50.30	53.20	
Е	.600	.625	15.24	15.87	
E1	.485	.580	12.32	14.73	
е	.100	BSC	2.54 BSC		
L	.115	.200	2.93	5.08	

PLCC



	Tolerances				
	(inc	(inches)		(mm)	
	Min	Max	Min	Мах	
Α	.165	.180	4.191	4.572	
A1	.090	.20	2.286	5.08	
A2	.062	.083	1.575	2.108	
C	.020	min	.508 min		
D	.685	.695	17.399	17.653	
D1	.650	.653	16.510	16.662	

Dimensions mm (inches)

For additional information please visit www.ixysic.com

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